

CXD3412GA

Timing Generator and Signal Processor for Frame Readout CCD Image Sensor

Description

The CXD3412GA is a timing generator and CCD signal processor IC for the ICX412 CCD image sensor.

Features

- Timing generator functions
 - Horizontal drive frequency 22.5MHz (base oscillation frequency 45MHz)
 - Supports frame readout/draft (sextuple speed)/ AF (auto focus)
 - High-speed/low-speed shutter function
 - Horizontal and vertical drivers for CCD image sensor
- CCD signal processor functions
- Correlated double sampling
- Programmable gain amplifier (PGA) allows gain adjustment over a wide range (-6 to +42dB)
- 10-bit A/D converter
- Chip Scale Package (CSP): CSP allows vast reduction in the CCD camera block footprint

Applications

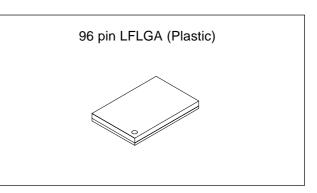
Digital still cameras

Structure

Silicon gate CMOS IC

Applicable CCD Image Sensors

ICX412 (Type 1/1.8, 3240K pixels)



Absolute Maximum Ratings

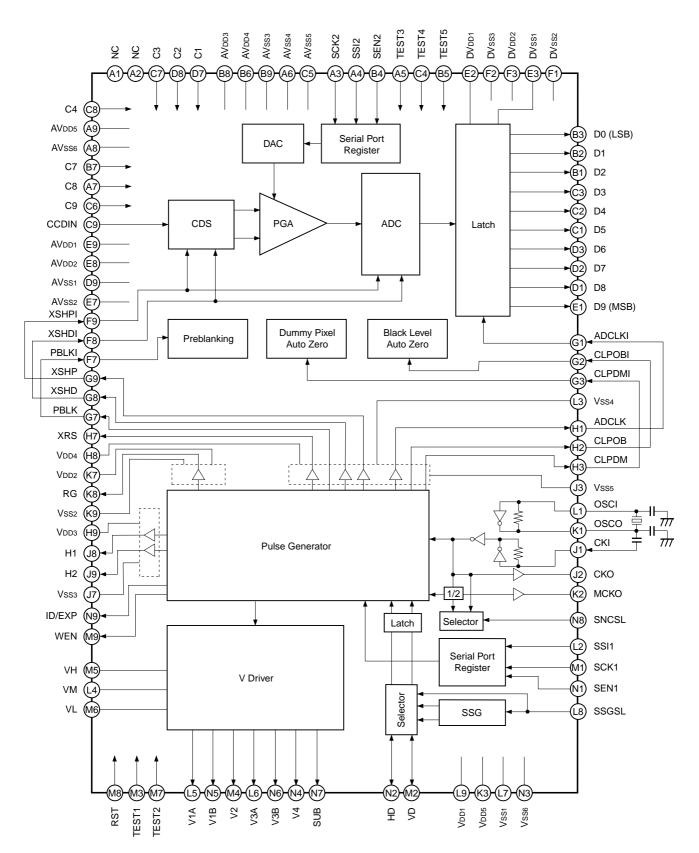
 Supply voltage 				
Vdda, Vddb, Vddc, Vddd	Vss – 0.3 to +7.0	V		
Vdde, Vddf, Vddg	Vss - 0.3 to +4.0	V		
VL	-10.0 to Vss	V		
VH	VL – 0.3 to +26.0	V		
 Input voltage (analog) 				
Vin	$\ensuremath{\text{Vss}}-0.3$ to $\ensuremath{\text{VdD}}$ + 0.3	V		
 Input voltage (digital) 				
VI	$\ensuremath{\text{Vss}}-0.3$ to $\ensuremath{\text{VdD}}$ + 0.3	V		
 Output voltage 				
Vo1	$\ensuremath{\text{Vss}}-0.3$ to $\ensuremath{\text{VdD}}$ + 0.3	V		
Vo2	VL - 0.3 to Vss + 0.3	V		
Vo ₃	VL – 0.3 to VH + 0.3	V		
 Operating temperature 				
Topr	-20 to +75	°C		
Storage temperature				
Tstg	–55 to +125	°C		

Recommended Operating Conditions

 Supply voltage 					
Vdd	3.0 to 5.5	V			
Vdda, Vddb, Vddc, Vddd,					
Vdde, Vddf, Vddg	3.0 to 3.6	V			
VM	0.0	V			
VH	14.5 to 15.5	V			
VL	-7.0 to -8.0	V			
 Operating temperature 					
Topr	-20 to +75	°C			

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Block Diagram



Pin Configuration (Top View)

А	NC	NC	SCK2	SSI2	TEST3	AVss4	C8	AVss6	AVdd5
В	D2	D1	D0	SEN2	TEST5	AVdd4	C7	AVdd3	AVss3
С	D5	D4	D3	TEST4	AVss5	C9	C3	C4	CCDIN
D	D8	D7	D6				C1	C2	AVss1
Е	D9	DVDD1	DVss1				AVss2	AVdd2	AVDD1
F	DVss2	DVss3	DVDD2				PBLKI	XSHDI	XSHPI
G	ADCLKI	CLPOBI	CLPDMI				PBLK	XSHD	XSHP
Н	ADCLK	CLPOB	CLPDM				XRS	Vdd4	Vdd3
J	СКІ	СКО	Vss5				Vss3	H1	H2
к	OSCO	мско	Vdd5				Vdd2	RG	Vss2
L	OSCI	SSI1	Vss4	VM	V1A	V3A	Vss1	SSGSL	Vdd1
М	SCK1	VD	TEST1	V2	VH	VL	TEST2	RST	WEN
Ν	SEN1	HD	Vss6	V4	V1B	V3B	SUB	SNCSL	ID/EXP
	1	2	3	4	5	6	7	8	9

Pin Description

A1 NC — No connected. (Open) A2 NC — No connected. (Open) A3 SCK2 I CCD signal processor block serial interface clock input. (Schmitt trigger) A4 SSI2 I CCD signal processor block serial interface data input. (Schmitt trigger) A4 SSI2 I CCD signal processor block analog GND. A6 AVsse — CCD signal processor block analog GND. A7 C8 — Capacitor connection. A8 AVsse — CCD signal processor block analog GND. A9 AVooc — CCD signal processor block analog power supply. B1 D2 O ADC output. D B3 D0 O ADC output (LSB). E B4 SEN2 I CCD signal processor block test input 5. Connect to DVoo. B6 AVooa — CCD signal processor block analog power supply. B7 C7 — Capacitor connection. B8 AVooa — CCD signal processor block analog power supply. B7 O7 — Capacitor connec	Pin No.	Symbol	I/O	Description
A3 SCK2 1 CCD signal processor block serial interface clock input. (Schmitt trigger) A4 SSI2 1 CCD signal processor block serial interface data input. (Schmitt trigger) A5 TEST3 1 CCD signal processor block test input 3. Connect to DVss. A6 AVss4 - CCD signal processor block analog GND. A7 C8 - Capacitor connection. A8 AVss6 - CCD signal processor block analog GND. A9 AVocc - CCD signal processor block analog power supply. B1 D2 O ADC output. B2 D1 O ADC output. B3 D0 O ADC output. (LSB). B4 SEN2 1 CCD signal processor block analog power supply. B5 TEST5 1 CCD signal processor block analog power supply. B6 AVoa - CCD signal processor block analog power supply. B7 C7 - Capacitor connection. B8 AVoa - CCD signal processor block analog power supply. B9 AVssa - CCD signal proces	A1	NC	_	No connected. (Open)
A4 SSI2 1 CCD signal processor block serial interface data input. (Schmitt trigger) A5 TEST3 1 CCD signal processor block test input 3. Connect to DVss. A6 AVss4 — CCD signal processor block analog GND. A7 C8 — Capacitor connection. A8 AVss6 — CCD signal processor block analog GND. A8 AVss6 — CCD signal processor block analog power supply. B1 D2 O ADC output. B2 B2 D1 O ADC output. B3 B3 D0 O ADC output. B4 SEN2 1 CCD signal processor block serial interface enable input. (Schmitt trigger) B5 TEST5 1 CCD signal processor block analog power supply. B6 AVbo3 — CCD signal processor block analog power supply. B7 C7 — Capacitor connection. B8 AVbo3 — CCD signal processor block analog power supply. B9 AVss3 — CCD signal processor block analog GND. C1 D5 O	A2	NC	_	No connected. (Open)
A5 TEST3 I CCD signal processor block test input 3. Connect to DVss. A6 AVss4 — CCD signal processor block analog GND. A7 C8 — Capacitor connection. A8 AVss6 — CCD signal processor block analog GND. A9 AVops — CCD signal processor block analog GND. A9 AVops — CCD signal processor block analog power supply. B1 D2 O ADC output. B2 D1 O ADC output. B3 D0 O ADC output. B4 SEN2 1 CCD signal processor block serial interface enable input. (Schmitt trigger) B5 TEST5 1 CCD signal processor block analog power supply. B7 C7 — Capacitor connection. B8 AVboa — CCD signal processor block analog power supply. B9 AVss3 — CCD signal processor block analog GND. C1 D5 O ADC output. C3 C3 D3 <td>A3</td> <td>SCK2</td> <td>I</td> <td>CCD signal processor block serial interface clock input. (Schmitt trigger)</td>	A3	SCK2	I	CCD signal processor block serial interface clock input. (Schmitt trigger)
A6 AVss4 — CCD signal processor block analog GND. A7 C8 — Capacitor connection. A8 AVss6 — CCD signal processor block analog GND. A9 AVops — CCD signal processor block analog power supply. B1 D2 O ADC output. B2 D1 O ADC output. B3 D0 O ADC output (LSB). B4 SEN2 I CCD signal processor block serial interface enable input. (Schmitt trigger) B5 TEST5 I CCD signal processor block analog power supply. B7 C7 — Capacitor connection. B8 AVop4 — CCD signal processor block analog power supply. B7 C7 — Capacitor connection. B8 AVop3 — CCD signal processor block analog GND. C1 D5 O ADC output. C2 D4 O ADC output. C3 D3 O ADC output. C4 TEST4 I CCD signal processor block analog GND.	A4	SSI2	I	CCD signal processor block serial interface data input. (Schmitt trigger)
A7 C8 — Capacitor connection. A8 AVss6 — CCD signal processor block analog GND. A9 AVbos — CCD signal processor block analog power supply. B1 D2 O ADC output. B2 D1 O ADC output. B3 D0 O ADC output (LSB). B4 SEN2 1 CCD signal processor block serial interface enable input. (Schmitt trigger) B5 TEST5 1 CCD signal processor block analog power supply. B4 SEN2 1 CCD signal processor block analog power supply. B7 C7 — Capacitor connection. B8 AVbo4 — CCD signal processor block analog power supply. B9 AVss3 — CCD signal processor block analog GND. C1 D5 O ADC output. C2 C2 D4 O ADC output. C3 C3 D3 O ADC output. C4 C4 TEST4 1 CCD signal processor block test input 4. Connect to DVss. C5 C5<	A5	TEST3	I	CCD signal processor block test input 3. Connect to DVss.
A8 AVss6 — CCD signal processor block analog GND. A9 AVbbs — CCD signal processor block analog power supply. B1 D2 O ADC output. B2 D1 O ADC output. B3 D0 O ADC output (LSB). B4 SEN2 I CCD signal processor block serial interface enable input. (Schmitt trigger) B5 TEST5 I CCD signal processor block test input 5. Connect to DVbo. B6 AVb04 — CCD signal processor block analog power supply. B7 C7 — Capacitor connection. B8 AVb03 — CCD signal processor block analog power supply. B9 AVss3 — CCD signal processor block analog GND. C1 D5 O ADC output. C2 D4 O ADC output. C3 D3 O ADC output. C4 TEST4 I CCD signal processor block test input 4. Connect to DVss. C5 AVss5 — CCD signal processor block analog GND. C6 C9 —	A6	AVss4	—	CCD signal processor block analog GND.
A9 AVbbs — CCD signal processor block analog power supply. B1 D2 O ADC output. B2 D1 O ADC output. B3 D0 O ADC output (LSB). B4 SEN2 I CCD signal processor block serial interface enable input. (Schmitt trigger) B5 TEST5 I CCD signal processor block test input 5. Connect to DVob. B6 AVbb4 — CCD signal processor block analog power supply. B7 C7 — Capacitor connection. B8 AVbb3 — CCD signal processor block analog power supply. B9 AVssa — CCD signal processor block analog GND. C1 D5 O ADC output. C2 D4 O ADC output. C3 D3 O ADC output. C4 TEST4 I CCD signal processor block test input 4. Connect to DVss. C5 AVsss — CCD signal processor block analog GND. C6 C9 — Capacitor connection. C8 C4 — Capacitor c	A7	C8	_	Capacitor connection.
B1 D2 O ADC output. B2 D1 O ADC output. B3 D0 O ADC output (LSB). B4 SEN2 1 CCD signal processor block serial interface enable input. (Schmitt trigger) B5 TEST5 1 CCD signal processor block test input 5. Connect to DVpp. B6 AVpo4 — CCD signal processor block analog power supply. B7 C7 — Capacitor connection. B8 AVpo3 — CCD signal processor block analog power supply. B9 AVss3 — CCD signal processor block analog GND. C1 D5 O ADC output. C2 D4 O ADC output. C3 D3 O ADC output. C4 TEST4 1 CCD signal processor block test input 4. Connect to DVss. C5 AVss5 — CCD signal processor block analog GND. C6 C9 — Capacitor connection. C7 C3 — Capacitor connection. C8 C4 — Capacitor connection.	A8	AVss6	—	CCD signal processor block analog GND.
B2 D1 O ADC output. B3 D0 O ADC output (LSB). B4 SEN2 I CCD signal processor block serial interface enable input. (Schmitt trigger) B5 TEST5 I CCD signal processor block test input 5. Connect to DVpp. B6 AVpo4 - CCD signal processor block analog power supply. B7 C7 - Capacitor connection. B8 AVpo3 - CCD signal processor block analog power supply. B9 AVss3 - CCD signal processor block analog GND. C1 D5 O ADC output. C2 D4 O ADC output. C3 D3 O ADC output. C4 TEST4 I CCD signal processor block test input 4. Connect to DVss. C5 AVss5 - CCD signal processor block analog GND. C6 C9 - Capacitor connection. C7 C3 - Capacitor connection. C8 C4 - Capacitor connection. C9 CDIN I CCD output.	A9	AVdd5	—	CCD signal processor block analog power supply.
B3 D0 O ADC output (LSB). B4 SEN2 I CCD signal processor block serial interface enable input. (Schmitt trigger) B5 TEST5 I CCD signal processor block test input 5. Connect to DVbb. B6 AVbb4 — CCD signal processor block analog power supply. B7 C7 — Capacitor connection. B8 AVbb3 — CCD signal processor block analog power supply. B9 AVss3 — CCD signal processor block analog GND. C1 D5 O ADC output. C2 D4 O ADC output. C3 D3 O ADC output. C4 TEST4 I CCD signal processor block test input 4. Connect to DVss. C5 AVss5 — CCD signal processor block analog GND. C6 C9 — Capacitor connection. C7 C3 — Capacitor connection. C7 C3 — Capacitor connection. C7 C3 — Capacitor connection. C8 C4 — Capacitor connection	B1	D2	0	ADC output.
B4 SEN2 I CCD signal processor block serial interface enable input. (Schmitt trigger) B5 TEST5 I CCD signal processor block test input 5. Connect to DVbb. B6 AVbb4 — CCD signal processor block analog power supply. B7 C7 — Capacitor connection. B8 AVbb3 — CCD signal processor block analog power supply. B9 AVss3 — CCD signal processor block analog GND. C1 D5 O ADC output. C2 D4 O ADC output. C3 D3 O ADC output. C4 TEST4 I CCD signal processor block test input 4. Connect to DVss. C5 AVss5 — CCD signal processor block analog GND. C6 C9 — Capacitor connection. C7 C3 — Capacitor connection. C8 C4 — Capacitor connection. C9 CDIN I CCD output signal input. D1 D8 O ADC output. D2 D7 O ADC output.	B2	D1	0	ADC output.
B5 TEST5 I CCD signal processor block test input 5. Connect to DVpp. B6 AVbp4 — CCD signal processor block analog power supply. B7 C7 — Capacitor connection. B8 AVbp3 — CCD signal processor block analog power supply. B9 AVss3 — CCD signal processor block analog GND. C1 D5 O ADC output. C2 D4 O ADC output. C3 D3 O ADC output. C4 TEST4 I CCD signal processor block test input 4. Connect to DVss. C5 AVsss — CCD signal processor block test input 4. Connect to DVss. C5 AVsss — CCD signal processor block test input 4. Connect to DVss. C6 C9 — Capacitor connection. C7 C3 — C2D signal processor block analog GND. C6 C9 — Capacitor connection. C7 C3 — Capacitor connection. C8 C4 — Capacitor connection. D9 DADC output. D <td>B3</td> <td>D0</td> <td>0</td> <td>ADC output (LSB).</td>	B3	D0	0	ADC output (LSB).
B6 AVbp4 — CCD signal processor block analog power supply. B7 C7 — Capacitor connection. B8 AVbp3 — CCD signal processor block analog power supply. B9 AVss3 — CCD signal processor block analog GND. C1 D5 O ADC output. C2 D4 O ADC output. C3 D3 O ADC output. C4 TEST4 I CCD signal processor block test input 4. Connect to DVss. C5 AVss5 — CCD signal processor block analog GND. C6 C9 — Capacitor connection. C7 C3 — Capacitor connection. C7 C3 — Capacitor connection. C7 C3 — Capacitor connection. C8 C4 — Capacitor connection. C9 CDIN I CCD output signal input. D1 D8 O ADC output. D2 D7 O ADC output. D3 D6 O ADC output.	B4	SEN2	Ι	CCD signal processor block serial interface enable input. (Schmitt trigger)
B7 C7 — Capacitor connection. B8 AVDD3 — CCD signal processor block analog power supply. B9 AVss3 — CCD signal processor block analog GND. C1 D5 O ADC output. C2 D4 O ADC output. C3 D3 O ADC output. C4 TEST4 I CCD signal processor block test input 4. Connect to DVss. C5 AVss5 — CCD signal processor block analog GND. C6 C9 — Capacitor connection. C7 C3 — Capacitor connection. C7 C3 — Capacitor connection. C7 C3 — Capacitor connection. C8 C4 — Capacitor connection. C9 CCDIN I CCD output signal input. D1 D8 O ADC output. D2 D7 O ADC output. D3 D6 O ADC output. D3 D6 O ADC output. D8	B5	TEST5	I	CCD signal processor block test input 5. Connect to DVDD.
B8 AVDD3 — CCD signal processor block analog power supply. B9 AVss3 — CCD signal processor block analog GND. C1 D5 O ADC output. C2 D4 O ADC output. C3 D3 O ADC output. C4 TEST4 I CCD signal processor block test input 4. Connect to DVss. C5 AVss5 — CCD signal processor block analog GND. C6 C9 — Capacitor connection. C7 C3 — Capacitor connection. C8 C4 — Capacitor connection. C9 CCDIN I CCD output signal input. D1 D8 O ADC output. D2 D7 O ADC output. D3 D6 O ADC output. D8 C2 — </td <td>B6</td> <td>AVdd4</td> <td>—</td> <td>CCD signal processor block analog power supply.</td>	B6	AVdd4	—	CCD signal processor block analog power supply.
B9 AVss3 — CCD signal processor block analog GND. C1 D5 O ADC output. C2 D4 O ADC output. C3 D3 O ADC output. C4 TEST4 I CCD signal processor block test input 4. Connect to DVss. C5 AVss5 — CCD signal processor block analog GND. C6 C9 — Capacitor connection. C7 C3 — Capacitor connection. C8 C4 — Capacitor connection. C9 CCDIN I CCD output signal input. D1 D8 O ADC output. D2 D7 O ADC output. D3 D6 O ADC output. D3 D6 O ADC output. D7 C1 — Capacitor connection. D8 C2 — Capacitor connection. D8 C2 — Capacitor connection. D8 C2 — Capacitor connection. D9 AVss1 <td< td=""><td>B7</td><td>C7</td><td>—</td><td>Capacitor connection.</td></td<>	B7	C7	—	Capacitor connection.
C1D5OADC output.C2D4OADC output.C3D3OADC output.C4TEST4ICCD signal processor block test input 4. Connect to DVss.C5AVss5—CCD signal processor block analog GND.C6C9—Capacitor connection.C7C3—Capacitor connection.C8C4—Capacitor connection.C9CCDINICCD output signal input.D1D8OADC output.D2D7OADC output.D3D6OADC output.D7C1—Capacitor connection.D8C2—Capacitor connection.D9AVss1—CCD signal processor block analog GND.E1D9OADC output (MSB).E2DVbp1—CCD signal processor block digital power supply. (Power supply for ADC)E3DVss1—CCD signal processor block digital GND. (GND for ADC)	B8	AVdd3	—	CCD signal processor block analog power supply.
C2D4OADC output.C3D3OADC output.C4TEST4ICCD signal processor block test input 4. Connect to DVss.C5AVsss-CCD signal processor block analog GND.C6C9-Capacitor connection.C7C3-Capacitor connection.C8C4-Capacitor connection.C9CCDINICCD output signal input.D1D8OADC output.D2D7OADC output.D3D6OADC output.D7C1-Capacitor connection.D9AVss1-CCD signal processor block analog GND.E1D9OADC output.E3DVss1-CCD signal processor block analog GND.E3DVss1-CCD signal processor block digital power supply. (Power supply for ADC)E3DVss1-CCD signal processor block digital GND. (GND for ADC)	B9	AVss3	—	CCD signal processor block analog GND.
C3D3OADC output.C4TEST4ICCD signal processor block test input 4. Connect to DVss.C5AVsss—CCD signal processor block analog GND.C6C9—Capacitor connection.C7C3—Capacitor connection.C8C4—Capacitor connection.C9CCDINICCD output signal input.D1D8OADC output.D2D7OADC output.D3D6OADC output.D7C1—Capacitor connection.D8C2—Capacitor connection.D9AVss1—CCD signal processor block analog GND.E1D9OADC output (MSB).E2DVbp1—CCD signal processor block digital power supply. (Power supply for ADC)E3DVss1—CCD signal processor block digital GND. (GND for ADC)	C1	D5	0	ADC output.
C4TEST4ICCD signal processor block test input 4. Connect to DVss.C5AVsss—CCD signal processor block analog GND.C6C9—Capacitor connection.C7C3—Capacitor connection.C8C4—Capacitor connection.C9CCDINICCD output signal input.D1D8OADC output.D2D7OADC output.D3D6OADC output.D7C1—Capacitor connection.D8C2—Capacitor connection.D9AVss1—CCD signal processor block analog GND.E1D9OADC output (MSB).E2DVbp1—CCD signal processor block digital power supply. (Power supply for ADC)E3DVss1—CCD signal processor block digital GND. (GND for ADC)	C2	D4	0	ADC output.
C5AVsss—CCD signal processor block analog GND.C6C9—Capacitor connection.C7C3—Capacitor connection.C8C4—Capacitor connection.C9CCDINICCD output signal input.D1D8OADC output.D2D7OADC output.D3D6OADC output.D7C1—Capacitor connection.D8C2—Capacitor connection.D9AVss1—CCD signal processor block analog GND.E1D9OADC output (MSB).E2DVbp1—CCD signal processor block digital GND. (GND for ADC)E3DVss1—CCD signal processor block digital GND. (GND for ADC)	C3	D3	0	ADC output.
C6C9—Capacitor connection.C7C3—Capacitor connection.C8C4—Capacitor connection.C9CCDINICCD output signal input.D1D8OADC output.D2D7OADC output.D3D6OADC output.D7C1—Capacitor connection.D8C2—Capacitor connection.D9AVss1—CCD signal processor block analog GND.E1D9OADC output (MSB).E2DVbD1—CCD signal processor block digital power supply. (Power supply for ADC)E3DVss1—CCD signal processor block digital GND. (GND for ADC)	C4	TEST4	Ι	CCD signal processor block test input 4. Connect to DVss.
C7C3—Capacitor connection.C8C4—Capacitor connection.C9CCDINICCD output signal input.D1D8OADC output.D2D7OADC output.D3D6OADC output.D7C1—Capacitor connection.D8C2—Capacitor connection.D9AVss1—CCD signal processor block analog GND.E1D9OADC output (MSB).E2DVbb1—CCD signal processor block digital power supply. (Power supply for ADC)E3DVss1—CCD signal processor block digital GND. (GND for ADC)	C5	AVss5	—	CCD signal processor block analog GND.
C8C4—Capacitor connection.C9CCDINICCD output signal input.D1D8OADC output.D2D7OADC output.D3D6OADC output.D7C1—Capacitor connection.D8C2—Capacitor connection.D9AVss1—CCD signal processor block analog GND.E1D9OADC output (MSB).E2DVbD1—CCD signal processor block digital power supply. (Power supply for ADC)E3DVss1—CCD signal processor block digital GND. (GND for ADC)	C6	C9	—	Capacitor connection.
C9CCDINICCD output signal input.D1D8OADC output.D2D7OADC output.D3D6OADC output.D7C1—Capacitor connection.D8C2—Capacitor connection.D9AVss1—CCD signal processor block analog GND.E1D9OADC output (MSB).E2DVpp1—CCD signal processor block digital power supply. (Power supply for ADC)E3DVss1—CCD signal processor block digital GND. (GND for ADC)	C7	C3	—	Capacitor connection.
D1D8OADC output.D2D7OADC output.D3D6OADC output.D7C1-Capacitor connection.D8C2-Capacitor connection.D9AVss1-CCD signal processor block analog GND.E1D9OADC output (MSB).E2DVbD1-CCD signal processor block digital power supply. (Power supply for ADC)E3DVss1-CCD signal processor block digital GND. (GND for ADC)	C8	C4	—	Capacitor connection.
D2D7OADC output.D3D6OADC output.D7C1-Capacitor connection.D8C2-Capacitor connection.D9AVss1-CCD signal processor block analog GND.E1D9OADC output (MSB).E2DVDD1-CCD signal processor block digital power supply. (Power supply for ADC)E3DVss1-CCD signal processor block digital GND. (GND for ADC)	C9	CCDIN	Ι	CCD output signal input.
D3D6OADC output.D7C1—Capacitor connection.D8C2—Capacitor connection.D9AVss1—CCD signal processor block analog GND.E1D9OADC output (MSB).E2DVpp1—CCD signal processor block digital power supply. (Power supply for ADC)E3DVss1—CCD signal processor block digital GND. (GND for ADC)	D1	D8	0	ADC output.
D7C1—Capacitor connection.D8C2—Capacitor connection.D9AVss1—CCD signal processor block analog GND.E1D9OADC output (MSB).E2DVDD1—CCD signal processor block digital power supply. (Power supply for ADC)E3DVss1—CCD signal processor block digital GND. (GND for ADC)	D2	D7	0	ADC output.
D8C2—Capacitor connection.D9AVss1—CCD signal processor block analog GND.E1D9OADC output (MSB).E2DVpp1—CCD signal processor block digital power supply. (Power supply for ADC)E3DVss1—CCD signal processor block digital GND. (GND for ADC)	D3	D6	0	ADC output.
D9 AVss1 CCD signal processor block analog GND. E1 D9 O ADC output (MSB). E2 DVpd1 CCD signal processor block digital power supply. (Power supply for ADC) E3 DVss1 CCD signal processor block digital GND. (GND for ADC)	D7	C1	—	Capacitor connection.
E1 D9 O ADC output (MSB). E2 DV _{DD1} — CCD signal processor block digital power supply. (Power supply for ADC) E3 DVss1 — CCD signal processor block digital GND. (GND for ADC)	D8	C2	—	Capacitor connection.
E2 DV _{DD1} — CCD signal processor block digital power supply. (Power supply for ADC) E3 DVss1 — CCD signal processor block digital GND. (GND for ADC)	D9	AVss1	—	CCD signal processor block analog GND.
E3 DVss1 — CCD signal processor block digital GND. (GND for ADC)	E1	D9	0	ADC output (MSB).
	E2	DVDD1	_	CCD signal processor block digital power supply. (Power supply for ADC)
E7 AVss ₂ — CCD signal processor block analog GND.	E3	DVss1	—	CCD signal processor block digital GND. (GND for ADC)
	E7	AVss2	_	CCD signal processor block analog GND.

Pin No.	Symbol	I/O	Description
E8	AVdd2	—	CCD signal processor block analog power supply.
E9	AVDD1	—	CCD signal processor block analog power supply.
F1	DVss2	—	CCD signal processor block digital GND.
F2	DVss3	—	CCD signal processor block digital GND.
F3	DVDD2	—	CCD signal processor block digital power supply.
F7	PBLKI	I	Pulse input for horizontal and vertical blanking period pulse cleaning. (Schmitt trigger)
F8	XSHDI	I	CCD data level sample-and-hold pulse input. (Schmitt trigger)
F9	XSHPI	Ι	CCD precharge level sample-and-hold pulse input. (Schmitt trigger)
G1	ADCLKI	Ι	Clock input for analog/digital conversion. (Schmitt trigger)
G2	CLPOBI	Ι	CCD optical black signal clamp pulse input. (Schmitt trigger)
G3	CLPDMI	Ι	CCD dummy signal clamp pulse input. (Schmitt trigger)
G7	PBLK	0	Pulse output for horizontal and vertical blanking period pulse cleaning.
G8	XSHD	0	CCD data level sample-and-hold pulse output.
G9	XSHP	0	CCD precharge level sample-and-hold pulse output.
H1	ADCLK	0	Clock output for analog/digital conversion. Logical phase can be adjusted by serial interface data.
H2	CLPOB	0	CCD optical black signal clamp pulse output. Horizontal/vertical OB pattern can be changed by serial interface data.
H3	CLPDM	0	CCD dummy signal clamp pulse output.
H7	XRS	0	Sample-and-hold pulse output for analog/digital conversion phase alignment.
H8	Vdd4	—	Timing generator block digital power supply. (Power supply for CDS block)
H9	Vdd3	—	Timing generator block 3.0 to 5.0V power supply. (Power supply for H1/H2)
J1	СКІ	Ι	Inverter input.
J2	СКО	0	Inverter output.
J3	Vss5	—	Timing generator block digital GND.
J7	Vss3	—	Timing generator block digital GND.
J8	H1	0	CCD horizontal register clock output.
J9	H2	0	CCD horizontal register clock output.
K1	OSCO	0	Inverter output for oscillation. When not used, leave open or connect a capacitor.
K2	МСКО	0	System clock output for signal processor IC.
K3	Vdd5	—	Timing generator block digital power supply. (Power supply for common logic block)
K7	Vdd2	—	Timing generator block digital power supply. (Power supply for RG)
K8	RG	0	CCD reset gate pulse output.
K9	Vss2	—	Timing generator block digital GND.
L1	OSCI	I	Inverter input for oscillation. When not used, fix to low.
L2	SSI1	Ι	Timing generator block serial interface data input. Schmitt trigger input.

Pin No.	Symbol	I/O	Description
L3	Vss4	—	Timing generator block digital GND.
L4	VM	_	Timing generator block digital GND. (GND for vertical driver)
L5	V1A	0	CCD vertical register clock output.
L6	V3A	0	CCD vertical register clock output.
L7	Vss1	—	Timing generator block digital GND.
L8	SSGSL	I	Internal SSG enable. High: Internal SSG valid, Low: External sync valid (With pull-down resistor)
L9	Vdd1	—	Timing generator block digital power supply. (Power supply for common logic block)
M1	SCK1	I	Timing generator block serial interface clock input. Schmitt trigger input.
M2	VD	I/O	Vertical sync signal input/output.
M3	TEST1	I	Timing generator block test input 1.(With pull-down resistor)Normally fix to GND.(With pull-down resistor)
M4	V2	0	CCD vertical register clock output.
M5	VH	—	Timing generator block 15.0V power supply. (Power supply for vertical driver)
M6	VL	_	Timing generator block –7.5V power supply. (Power supply for vertical driver)
M7	TEST2	I	Timing generator block test input 2.(With pull-down resistor)Normally fix to GND.(With pull-down resistor)
M8	RST	I	Timing generator block reset input. High: Normal operation, Low: Reset control Normally apply reset during power-on. Schmitt trigger input/No protective diode on power supply side.
M9	WEN	0	Memory write timing pulse output.
N1	SEN1	I	Timing generator block serial interface strobe input. Schmitt trigger input.
N2	HD	I/O	Horizontal sync signal input/output.
N3	Vss6	_	Timing generator block digital GND.
N4	V4	0	CCD vertical register clock output.
N5	V1B	0	CCD vertical register clock output.
N6	V3B	0	CCD vertical register clock output.
N7	SUB	0	CCD electronic shutter pulse output.
N8	SNCSL	1	Control input used to switch sync system.High: CKI sync, Low: MCKO sync(With pull-down resistor)
N9	ID/EXP	0	Vertical direction line identification pulse output/exposure time identification pulse output. Switching possible using the serial interface data. (Default: ID)

Electrical Characteristics

Timing Generator Block Electrical Characteristics

DC Characteristics

(Within the recommended operating conditions)

Item	Pins	Symbol	Conditions	Min.	Тур.	Max.	Unit
Supply voltage 1	Vdd2	Vdda		3.0	3.3	3.6	V
Supply voltage 2	Vdd3	Vddb		3.0	3.3	5.25	V
Supply voltage 3	Vdd4	Vddc		3.0	3.3	3.6	V
Supply voltage 4	Vdd1, Vdd5	Vddd		3.0	3.3	3.6	V
Input	RST, SSI1,	VI+		0.8Vodd			V
voltage 1*1	SCK1, SEN1	VI-				0.2Vpd	V
Input	TEST1, TEST2,	VIH1		0.7Vod			V
voltage 2*2	SNCSL, SSGSL	VIL1				0.3Vddd	V
		Vih2		0.8Vodd			V
Input/output		VIL2				0.2Vpd	V
voltage	VD, HD	Vон1	Feed current where $I_{OH} = -1.2 \text{mA}$	Vod – 0.8			V
		Vol1	Pull-in current where IoL = 2.4mA			0.4	V
Output		Vон2	Feed current where $I_{OH} = -22.0 \text{mA}$	Vodb – 0.8			V
voltage 1	H1, H2	Vol2	Pull-in current where IoL = 14.4mA			0.4	V
Output	RG	Vонз	Feed current where $I_{OH} = -3.3 \text{mA}$	Vdda - 0.8			V
voltage 2		Vol3	Pull-in current where IoL = 2.4mA			0.4	V
Output	XSHP, XSHD, XRS, PBLK, CLPOB, CLPDM, ADCLK	Vон4	Feed current where IoH = -3.3mA	VDDC - 0.8			V
voltage 3		Vol4	Pull-in current where IoL = 2.4mA			0.4	V
Output	СКО	Vон5	Feed current where IOH = -6.9mA	VDDd - 0.8			V
voltage 4	CINO	Vol5	Pull-in current where IoL = 4.8mA			0.4	V
Output	мско	Vон6	Feed current where $I_{OH} = -3.3 \text{mA}$	VDDd - 0.8			V
voltage 5	MCRO	Vol6	Pull-in current where IoL = 2.4mA			0.4	V
Output	ID/EXP,	Vон7	Feed current where $I_{OH} = -2.4 \text{mA}$	VDDd - 0.8			V
voltage 6	WEN	Vol7	Pull-in current where IoL = 4.8mA			0.4	V
		Iol	V1A/B, V2, V3A/B, V4 = -8.25V	10.0			mA
Output	V1A, V1B, V3A, V3B,	Іом1	V1A/B, V2, V3A/B, V4 = -0.25V			-5.0	mA
current 1	V2, V4	Іом2	V1A/B, V3A/B = 0.25V	5.0			mA
		Іон	V1A/B, V3A/B = 14.75V			-7.2	mA
Output		Iosl	SUB = -8.25V	5.4			mA
current 2	SUB	losн	SUB = 14.75V			-4.0	mA

*1 This input pin is a schmitt trigger input and it has protective diode of the power supply side in the IC. It is not supported to 5V input.

*2 These input pins are with pull-down resistor in the IC.

Note) This table indicates the conditions for 3.3V drive.

Item	Pins	Symbol	Conditions	Min.	Тур.	Max.	Unit
Logical Vth	OSCI	LVth			Vdd/2		V
Input	OSCI	Vін		0.7Vpd			V
voltage	0501	VIL				0.3Vddd	V
Output	OSCO	Vон	Feed current where $IOH = -3.6mA$	Vdd - 0.8			V
voltage		Vol	Pull-in current where IoL = 2.4mA			0.4	V
Feedback resistor	OSCI, OSCO	RFB	VIN = VDDd or VSS	500k	2M	5M	Ω
Oscillation frequency	OSCI, OSCO	f		20		50	MHz

Inverter I/O Characteristics for Oscillation

(Within the recommended operating conditions)

Inverter Input Characteristics for Base Oscillation Clock Duty Adjustment

(Within the recommended operating conditions)

Item	Pins	Symbol	Conditions	Min.	Тур.	Max.	Unit
Logical Vth		LVth			Vdd/2		V
Input		Vін		0.7Vddd			V
voltage	СКІ	Vi∟				0.3Vddd	V
Input amplitude		Vin	fmax 50MHz sine wave	0.3			Vр-р

Note) Input voltage is the input voltage characteristics for direct input from an external source.

Input amplitude is the input amplitude characteristics in the case of input through a capacitor.

Switching Characteristics

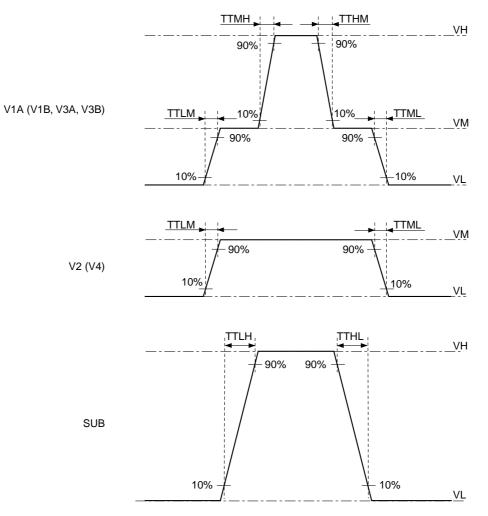
(VH = 15.0V, VM = GND, VL = -7.5V)

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
	TTLM	VL to VM	200	350	500	ns
Rise time	ттмн	VM to VH	200	350	500	ns
	TTLH	VL to VH	30	60	90	ns
	TTML	VM to VL	200	350	500	ns
Fall time	ТТНМ	VH to VM	200	350	500	ns
	TTHL	VH to VL	30	60	90	ns
	VCLH				1.0	V
	VCLL				1.0	V
Output noise voltage	VCMH				1.0	V
	VCML				1.0	V

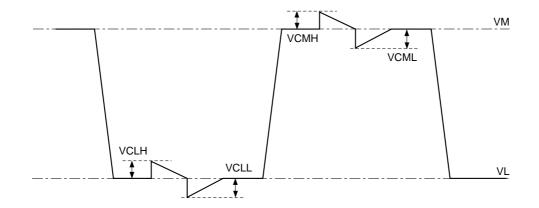
Notes)

- 1. The MOS structure of this IC has a low tolerance for static electricity, so full care should be given for measures to prevent electrostatic discharge.
- For noise and latch-up countermeasures, be sure to connect a by-pass capacitor (0.1µF or more) between each power supply pin (VH, VL) and GND.
- 3. To protect the CCD image sensor, clamp the SUB pin output at VH before input to the CCD image sensor.

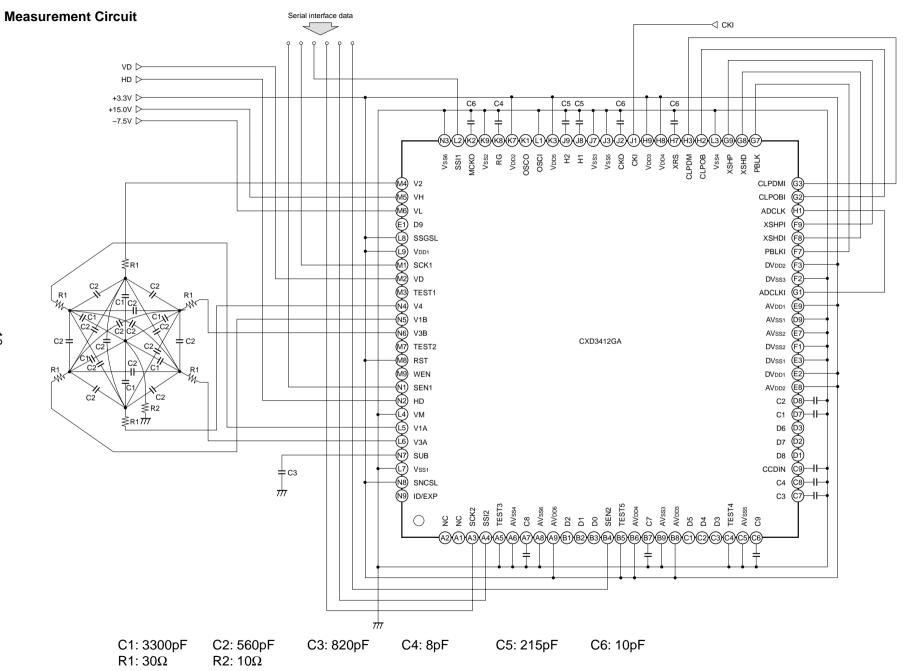
Switching Waveforms



Waveform Noise

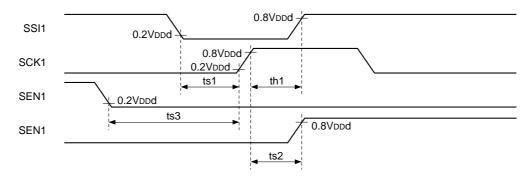






AC Characteristics

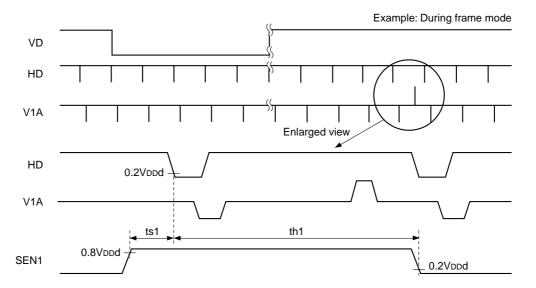
AC characteristics between the serial interface clocks



(Within the recommended operating conditions)

Symbol	Definition	Min.	Тур.	Max.	Unit
ts1	SSI1 setup time, activated by the rising edge of SCK1	20			ns
th1	SSI1 hold time, activated by the rising edge of SCK1	20			ns
ts2	SCK1 setup time, activated by the rising edge of SEN1	20			ns
ts3	SEN1 setup time, activated by the rising edge of SCK1	20			ns

Serial interface clock internal loading characteristics (1)

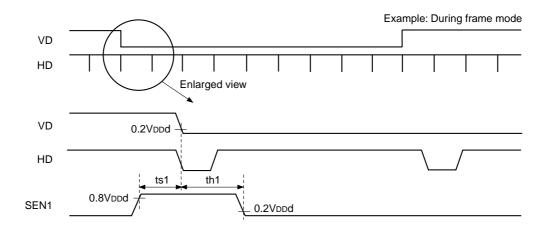


* Be sure to maintain a constantly high SEN1 logic level near the falling edge of the HD in the horizontal period during which V1A/B and V3A/B values take the ternary value and during that horizontal period.

Symbol	Definition	Min.	Тур.	Max.	Unit
ts1	SEN1 setup time, activated by the falling edge of HD	0			ns
th1	SEN1 hold time, activated by the falling edge of HD	113			μs

(Within the recommended operating conditions)

Serial interface clock internal loading characteristics (2)



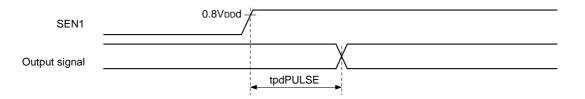
* Be sure to maintain a constantly high SEN1 logic level near the falling edge of VD.

(Within the recommended operating conditions)

Symbol	Definition		Тур.	Max.	Unit
ts1	ts1 SEN1 setup time, activated by the falling edge of VD				ns
th1 SEN1 hold time, activated by the falling edge of VD		200			ns

Serial interface clock output variation characteristics

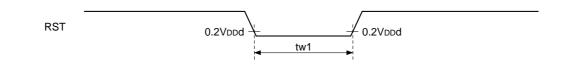
Normally, the serial interface data is loaded to the CXD3412GA at the timing shown in "Serial interface clock internal loading characteristics (1)" above. However, one exception to this is when the data such as STB is loaded to the CXD3412GA and controlled at the rising edge of SEN1. See "Description of Operation".



(Within the recommended operating conditions)

Symbol	Definition		Тур.	Max.	Unit
tpdPULSE	Output signal delay, activated by the rising edge of SEN1	15		100	ns

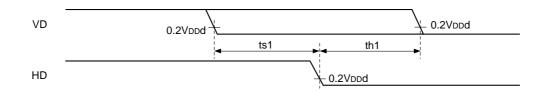
RST loading characteristics



(Within the recommended operating conditions)

Symbol	Definition	Min.	Тур.	Max.	Unit
tw1	RST pulse width	28			ns

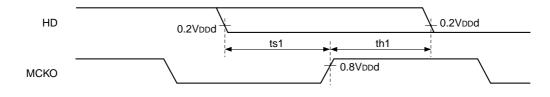
VD and HD phase characteristics



(Within the recommended operating conditions)

Symbol	Definition		Тур.	Max.	Unit
ts1	VD setup time, activated by the falling edge of HD	0			ns
th1	VD hold time, activated by the falling edge of HD	0			ns

HD loading characteristics

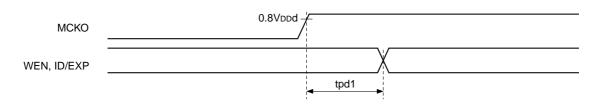


MCKO load capacitance = 10pF

(Within the recommended operating conditions)

Symbol	Definition		Тур.	Max.	Unit
ts1	ts1 HD setup time, activated by the rising edge of MCKO				ns
th1 HD hold time, activated by the rising edge of MCKO		0			ns

Output variation characteristics



WEN and ID/EXP load capacitance = 10pF

(Within the recommended operating conditions)

Symbol	Definition		Тур.	Max.	Unit
tpd1	tpd1 Time until the above outputs change after the rise of MCKO			70	ns

CCD Signal Processor Block Electrical Characteristics

DC Characteristics

(Fc = 22.5MSPS, DVDD1, 2 = AVDD1, 2, 3, 4, 5 = 3.3V, Ta = 25°C)

Item	Pins	Symbol	Conditions	Min.	Тур.	Max.	Unit
Supply voltage 1	DVdd1	Vdde		3.0	3.3	3.6	V
Supply voltage 2	DVDD2	Vddf		3.0	3.3	3.6	V
Supply voltage 3	AVdd1, AVdd2, AVdd3, AVdd4, AVdd5	Vddg		3.0	3.3	3.6	V
Analog input capacitance	CCDIN	CIN			15		pF
	SCK2, SSI2,	VI+			1.8		V
Input voltage	SEN2, TEST3, TEST4, XSHDI, XSHPI, ADCLKI, CLPOBI, CLPDMI, PBLKI	VI–			1.1		V
A/D clock duty	ADCLKI				50		%
	D0 to D0	Vон	Feed current where $IOH = -2.0mA$	Vdde - 0.9			V
Output voltage	D0 to D9	Vol	Pull-in current where IoL = 2.0mA			0.4	V

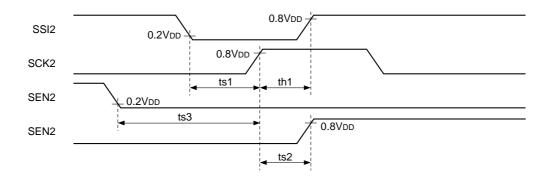
Analog Characteristics

(Fc = 22.5MSPS, DVDD1, 2 = AVDD1, 2, 3, 4, 5 = 3.3V, Ta = 25°C)

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
CCDIN input voltage amplitude	Vin	PGA gain = 0dB, output full scale	900		1100	mV
PGA maximum gain	Gmax	PGA gain setting data = "3FFh"		42		dB
PGA minimum gain	Gmin	PGA gain setting data = "000h"		-6		dB
ADC resolution				10		bit
ADC maximum conversion rate	Fc max		22.5			MHz
ADC integral non-linearity error	EL	PGA gain = 0dB		±1.0		LSB
ADC differential non-linearity error	ED	PGA gain = 0dB		±0.5		LSB
Signal-to-noise ratio	SNR	CCDIN input connected to GND via a coupling capacitor PGA gain = 0dB		77		dB
CCDIN input voltage clamp level	CLP			1.5		V
CCD optical black signal clamp level	ОВ	OBLVL = "8h" PGA gain = 0dB		32		LSB

AC Characteristics

AC characteristics between the serial interface clocks

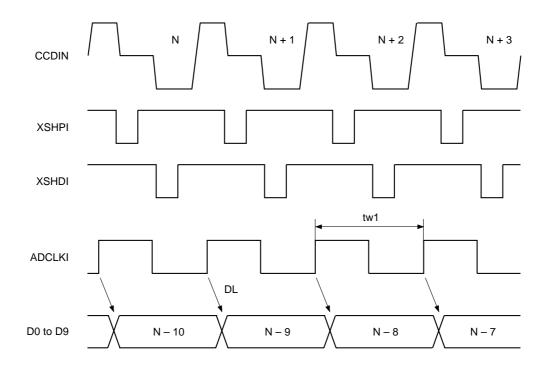


* The setting values are reflected to the operation 6 ADCLKI clocks after the serial data is loaded at the rise of SEN2.

(Fc = 22.5MSPS, DVDD1, 2	= AVDD1,	2, 3, 4, 5 = 3	3.3V, Ta =	25°C)	
Definition	Min.	Тур.	Max.	Unit	

Symbol	Definition		Тур.	Max.	Unit
tp1	SCK2 clock period	100			ns
ts1	SSI2 setup time, activated by the rise of SCK2	30			ns
th1	th1 SSI2 hold time, activated by the rise of SCK2				ns
ts2 SCK2 setup time, activated by the rise of SEN2		30			ns
ts3	SEN2 setup time, activated by the rise of SCK2	30			ns

CDS/ADC Timing Chart

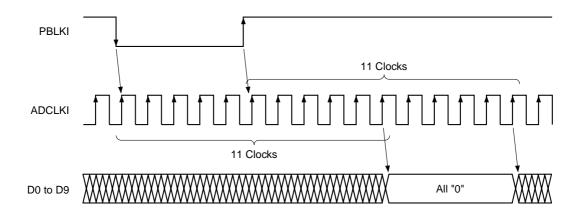


* Set the input pulse polarity setting data D13, D14 and D15 of the serial interface data to "0".

(Fc = 22.5MSPS,	DVDD1, 2 = AVDD1, 2, 3, 4, 5 =	= 3.3V, Ta = 25°C)
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Symbol	Definition		Тур.	Max.	Unit
tw1	ADCLKI clock period	44			ns
	ADCLKI clock duty		50		%
DL	Data latency		9		clocks

Preblanking Timing Chart



Description of Operation

Pulses output from the CXD3412GA's timing generator block are controlled mainly by the RST pin and by the serial interface data. The Pin Status Table is shown below, and the details of serial interface control are described on page 20 and thereafter.

Pin Status Table

Pin No.	Symbol	CAM	SLP	STB	RST	Pin No.	Symbol	CAM	SLP	STB	RST
A1	NC		_			D8	C2	—			
A2	NC		_			D9	AVss1	_			
A3	SCK2		_	_		E1	D9		-	_	
A4	SSI2		_	_		E2	DVdd1		_	_	
A5	TEST3		_	_		E3	DVss1		-	_	
A6	AVss4		_	_		E7	AVss2		_	_	
A7	C8		_	_		E8	AVdd2		_	_	
A8	AVss6		_	_		E9	AVdd1		_	_	
A9	AVdd5		_	_		F1	DVss2		_	_	
B1	D2		_	_		F2	DVss3		_	_	
B2	D1		_	_		F3	DVdd2		_	_	
B3	D0		_			F7	PBLKI				
B4	SEN2		_			F8	XSHDI	—			
B5	TEST5		_			F9	XSHPI	—			
B6	AVDD4		_			G1	ADCLKI	_			
B7	C7		_	_		G2	CLPOBI	—			
B8	AVdd3		_	_		G3	CLPDMI	—			
B9	AVss3		_	_		G7	PBLK	ACT	L	L	Н
C1	D5		_	_		G8	XSHD	ACT	L	L	ACT
C2	D4		_	_		G9	XSHP	ACT	L	L	ACT
C3	D3		_	_		H1	ADCLK	ACT	L	L	ACT
C4	TEST4		_	_		H2	CLPOB	ACT	L	L	Н
C5	AVss5		_	_		H3	CLPDM	ACT	L	L	Н
C6	C9		_	-		H7	XRS	ACT	L	L	ACT
C7	C3	_		H8	Vdd4	—					
C8	C4	_			H9	Vdd3	_				
C9	CCDIN	_			J1	CKI	ACT	ACT	ACT	ACT	
D1	D8				J2	СКО	ACT	ACT	L	ACT	
D2	D7		_			J3	Vss5			_	
D3	D6			_		J7	Vss3			_	
D7	C1					J8	H1	ACT	L	L	ACT

Pin No.	Symbol	CAM	SLP	STB	RST	Pin No.	Symbol	CAM	SLP	STB	RST
J9	H2	ACT	L	L	ACT	M2	VD*1	ACT	L	L	Н
K1	OSCO	ACT	ACT	ACT	ACT	М3	TEST1		_	_	
K2	МСКО	ACT	ACT	L	ACT	M4	V2	ACT	VM	VM	VM
K3	Vdd5		_			M5	VH		-		
K7	Vdd2		_	_		M6	VL		-	_	
K8	RG	ACT	L	L	ACT	M7	TEST2	—			
K9	Vss2		_			M8	RST	ACT	ACT	ACT	L
L1	OSCI	ACT	ACT	ACT	ACT	M9	WEN	ACT	L	L	L
L2	SSI1	ACT	ACT	ACT	DIS	N1	SEN1	ACT	ACT	ACT	DIS
L3	Vss4		_	_		N2	HD*1	ACT	L	L	Н
L4	VM		_			N3	Vss6	—			
L5	V1A	ACT	VH	VH	VM	N4	V4	ACT	VM	VM	VL
L6	V3A	ACT	VH	VH	VL	N5	V1B	ACT	VH	VH	VM
L7	Vss1		I			N6	V3B	ACT	VH	VH	VL
L8	SSGSL	ACT	ACT	ACT	ACT	N7	SUB	ACT	VH	VH	VL
L9	Vdd1		—			N8	SNCSL	ACT	ACT	ACT	ACT
M1	SCK1	ACT	ACT	ACT	DIS	N9	ID/EXP	ACT	L	L	L

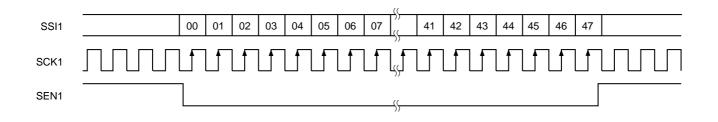
*1 It is for output. For input, all items are "ACT".

Note) ACT means that the circuit is operating, and DIS means that loading is stopped.
 L indicates a low output level, and H a high output level in the controlled status.
 Also, VH, VM and VL indicate the voltage levels applied to VH (Pin M5), VM (Pin L3) and VL (Pin M6), respectively, in the controlled status.

Timing Generator Block Serial Interface Control

The CXD3412GA's timing generator block basically loads and reflects the timing generator block serial interface data sent in the following format in the readout portion at the falling edge of HD. Here, readout portion specifies the horizontal period during which V1A/B and V3A/B, etc. take the ternary value.

Note that some items reflect the timing generator block serial interface data at the falling edge of VD or the rising edge of SEN1.



There are two categories of timing generator block serial interface data: CXD3412GA timing generator block drive control data (hereafter "control data") and electronic shutter data (hereafter "shutter data"). The details of each data are described below.

Control Data

Data	Symbol	Sunction	Data = 0	Data = 1	RST
D00 to D07	CHIP	Chip enable	10000001 Other values	All 0	
D08, D09	CTG	Category switching	See D08 to	D09 CTG.	All 0
D10 to D12	MODE	Drive mode switching	See D10 to	D12 MODE.	All 0
D13	SMD	Electronic shutter mode switching*1	OFF	ON	0
D14	HTSG	HTSG control switching*1	OFF	ON	0
D15	PTSG	Internal SSG function switching	NTSC equivalent	PAL equivalent	0
D16 to D31	_	_	_	_	All 0
D32	FGOB	Wide CLPOB generation switching*2	OFF	ON	0
D33	EXP	ID/EXP output switching	ID	EXP	0
D34, D35	РТОВ	CLPOB waveform pattern switching	See D34 to	All 0	
D36, D37	LDAD	ADCLK logic phase switching	See D36 to D37 LDAD.		1 0
D38, D39	STB	Standby control	See D38 to	D39 STB.	All 0
D40 to D47	_	_	_		All 0

*1 See D13 SMD.

*2 See D32 FGOB.

Shutter Data

Data	Symbol	Function	Data = 0	Data = 1	RST
D00 to D07	CHIP	Chip enable	10000001 Other values	All 0	
D08, D09	CTG	Category switching	See D08 to	All 0	
D10 to D19	SVD	Electronic shutter vertical period specification	See D10 to	D19 SVD.	All 0
D20 to D31	SHD	Electronic shutter horizontal period specification	See D20 to	D31 SHD.	All 0
D32 to D41	SPL	High-speed shutter position specification	See D32 to	D41 SPL.	All 0
D42 to D47			_	_	All 0

Detailed Description of Each Data

Shared data: D08, D09 CTG [Category]

Of the data provided to the CXD3412GA by the serial interface, the CXD3412GA loads D10 and subsequent data to each data register as shown in the table below according to the conbination of D08 and D09.

D09	D08	Description of operation	
0	0	Loading to control data register	
0	1	Loading to shutter data register	
1	Х	Test mode	

Note that the CXD3412GA can apply these categories consecutively within the same vertical period. However, care should be taken as the data is overwritten if the same category is applied.

Control data: D10 to D12 MODE [Drive mode]

The CXD3412GA timing generator block drive mode can be switched as follows. However, the drive mode bits are loaded to the CXD3412GA and reflected at the falling edge of VD.

D12	D11	D10	Description of operation	
0	0	0	Draft mode (sextuple speed: default)	
0	0	1	Frame mode (A field read out)	
0	1	0	Frame mode (B field read out)	
0	1	1	Frame mode	
1	0	Х	AF1 mode	
1	1	Х	AF2 mode	

Control data: D15 PTSG [Internal SSG output pattern]

The CXD3412GA internal SSG output pattern can be switched as follows. However, the internal SSG output pattern bits are loaded to the CXD3412GA and reflected at the falling edge of VD.

D15	Description of operation			
0	NTSC equivalent pattern output			
1	PAL equivalent pattern output			

VD period in each pattern is defined as follows. However, care should be taken that HD period is changing by the mode.

	Frame mode	Draft mode	AF1 mode	AF2 mode
NTSC equivalent pattern	885H + 810ck	$285H + 1455ck \times 2$	142H + 1384ck + 1383ck	71H + 1384ck
PAL equivalent pattern	884H + 1104ck	342H + 2592ck	171H + 1296ck	85H + 1960ck

See the Timing Charts for the actual operation.

Control data: D32 FGOB [Wide CLPOB generation]

This controls wide CLPOB generation during the vertical OPB period. See the Timing Charts for the actual operation. The default is "OFF".

D32	Description of operation
0	Wide CLPOB generation OFF
1	Wide CLPOB generation ON

Control data: D34, D35 PTOB [CLPOB waveform pattern]

This indicates the CLPOB waveform pattern. The default is "Normal".

D35	D34	Waveform	pattern
0	0		(Normal)
0	1		(Shifted rearward)
1	0		(Shifted forward)
1	1		(Wide)

Control data: D36, D37 LDAD [ADCLK logic phase]

This indicates the ADCLK logic phase adjustment data. The default is 90° relative to MCKO.

D37	D36	Degree of adjustment (°)
0	0	0
0	1	90
1	0	180
1	1	270

Control data: D38, D39 STB [Standby]

The operating mode is switched as follows. However, the standby bits are loaded to the CXD3412GA and control is applied immediately at the rising edge of SEN1.

D39	D38	Symbol	Operating mode
Х	0	CAM	Normal operating mode
0	1	SLP	Sleep mode
1	1	STB	Standby mode

See the Pin Status Table for the pin status in each mode.

Control data/shutter data: [Electronic shutter]

The CXD3412GA realizes various electronic shutter functions by using control data D13 SMD and D14 HTSG and shutter data D10 to D19 SVD, D20 to D31 SHD and D32 to D41 SPL.

These functions are described in detail below.

First, the various modes are shown below. These modes are switched using control data D13 SMD.

D13	Description of operation
0	Electronic shutter stopped mode
1	Electronic shutter mode

The electronic shutter data is expressed as shown in the table below using D20 to D31 SHD as an example. However, MSB (D31) is a reserve bit for the future specification, and it is handled as a dummy on this IC.

MSB											LSB
D31	D30	D29	D28	D27	D26	D25	D24	D23	D22	D21	D20
X	0	0	1	1	1	0	0	0	0	1	1
\downarrow			\downarrow			\downarrow					
	1				0)			3	3	

SHD is expressed as 1C3h

[Electronic shutter stopped mode]

During this mode, all shutter data items are invalid.

SUB is not output in this mode, so the shutter speed is the accumulation time for one field.

[Electronic shutter mode]

During this mode, the shutter data items have the following meanings.

Symbol	Data	Description
SVD	D10 to D19	Number of vertical periods specification (000h \leq SVD \leq 3FFh)
SHD	D20 to D31	Number of horizontal periods specification (000h \leq SHD \leq 7FFh)
SPL	D32 to D41	Vertical period specification for high-speed shutter operation (000h \leq SPL \leq 3FFh)

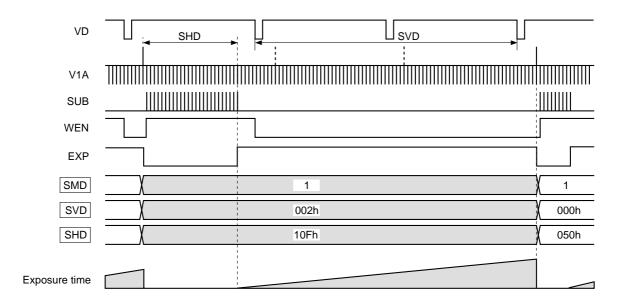
Note) The bit data definition area is assured in terms of the CXD3412GA functions, and does not assure the CCD characteristics.

The period during which SVD and SHD are specified together is the shutter speed. An image of the exposure time calculation formula is shown below. In actual operation, the precise exposure time is calculated from the operating frequency, VD and HD periods, decoding value during the horizontal period, and other factors.

(Exposure time) = SVD + {(number of HD per 1V) - (SHD + 1)}

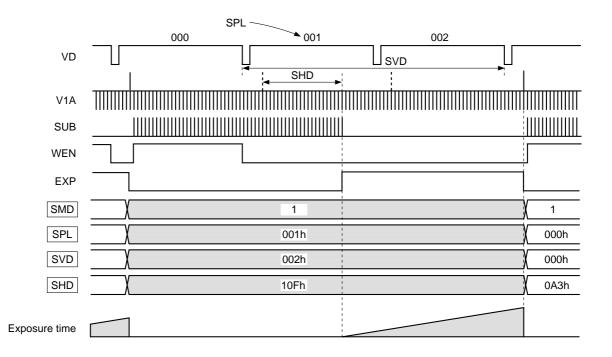
Concretely, when specifying high-speed shutter, SVD is set to "000h". (See the figure.) During low-speed shutter, or in other words when SVD is set to "001h" or higher, the serial interface data is not loaded until this period is finished.

The vertical period indicated here corresponds to one field in each drive mode. In addition, the number of horizontal periods applied to SHD can be considered as (number of SUB pulses -1).



Further, SPL can be used during this mode to specify the SUB output at the desired vertical period during the low-speed shutter period.

In the case below, SUB is output based on SHD at the SPL vertical period out of (SVD + 1) vertical periods.



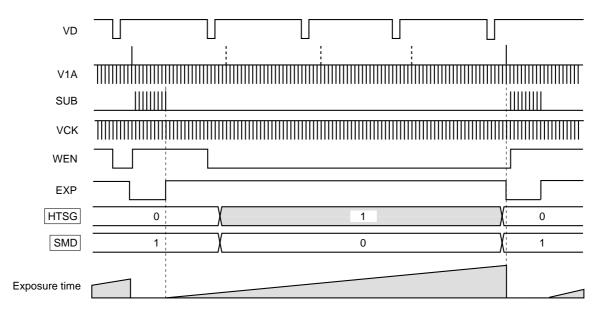
Incidentally, SPL is counted as "000h", "001h", "002h" and so on in conformance with SVD. At this time, performing SPL > SVD setting applies to the state of SPL = SVD correspondingly.

Using this function it is possible to achieve smooth exposure time transitions when changing from low-speed shutter to high-speed shutter or vice-versa.

[HTSG control mode]

This mode controls the V1A/B and V3A/B ternary level outputs (readout pulse block) using D14 HTSG. When control starts, V pulse modulation during readout period is not generated and the normal V transfer is performed.

D14	Description of operation
0	Readout pulse (SG) normal operation
1	HTSG control mode



[EXP pulse]

The ID/EXP (Pin 9) output can be switched between the ID pulse or the EXP pulse using D33 EXP. The default is the "ID" pulse. See the Timing Charts for the ID pulse. The EXP pulse indicates the exposure time when it is high. In the draft mode, the transition point is the last SUB pulse falling edge, and midpoint value (1443ck) of each V1A/B and V3A/B ternary output falling edge. When there is no SUB pulse, the later ternary output falling edge (1538ck) is used. In the frame mode, the transition point is the last SUB pulse falling edge, and each V1A/B and V3A/B ternary output falling edge (1348ck). When there is no SUB pulse, the V pulse modulation falling edge just after ternary output (1386ck) is used. In addition, switching from ID to EXP is performed at the timing (ID transition point of the horizontal period where V1A/B and V3A/B ternary output) and reset to low.

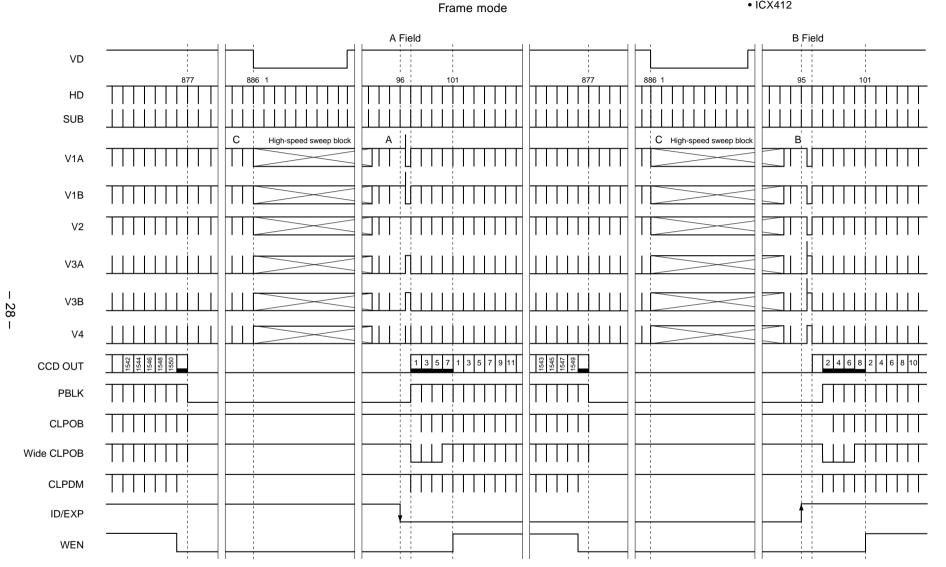
See the EXP pulse indicated in the explanatory diagrams under Electronic Shutter for an image of operation.

Chart-1 Vertical Direction Timing Chart



Applicable CCD image sensor

• ICX412

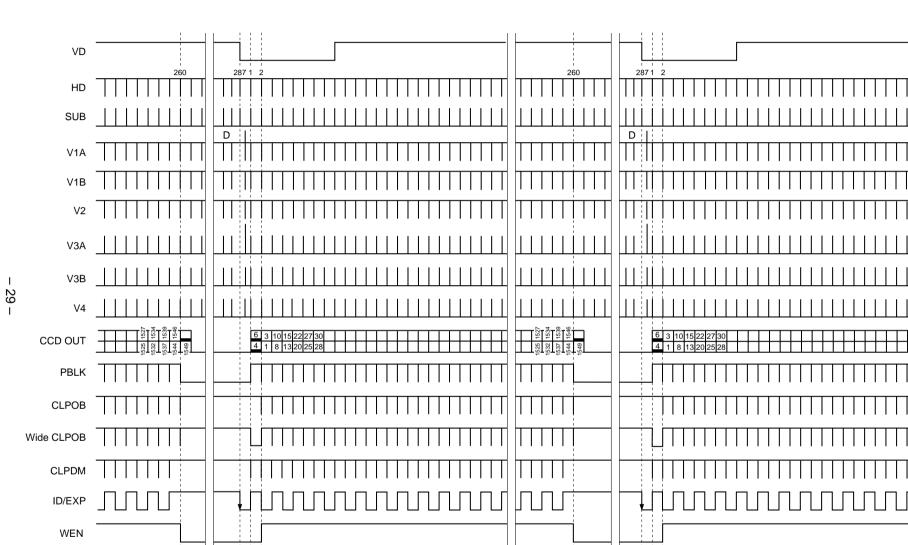


* The number of SUB pulses is determined by the serial interface data. This chart shows the case where SUB pulses are output in each horizontal period.

* ID/EXP of this chart shows ID. ID is low for lines where CCD OUT contains the R component, and high for lines where CCD OUT contains the B component.

* 1560 stages are fixed for high-speed sweep block.

* VD of this chart is NTSC equivalent pattern (885H + 810ck units). For PAL equivalent pattern, it is 884H + 1104ck units.



* The number of SUB pulses is determined by the serial interface data. This chart shows the case where SUB pulses are output in each horizontal period.

* ID/EXP of this chart shows ID. ID is low for lines where CCD OUT contains the R component, and high for lines where CCD OUT contains the B component.

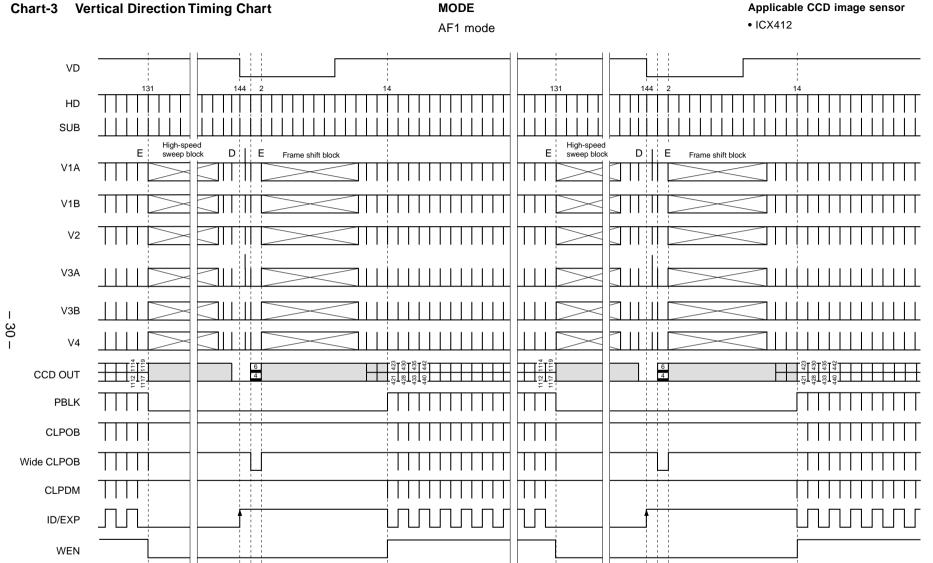
* VD of this chart is NTSC equivalent pattern (285H + 1455ck + 1455ck units). For PAL equivalent pattern, it is 342H + 2592ck units.

Applicable CCD image sensor

• ICX412

MODE

Draft mode



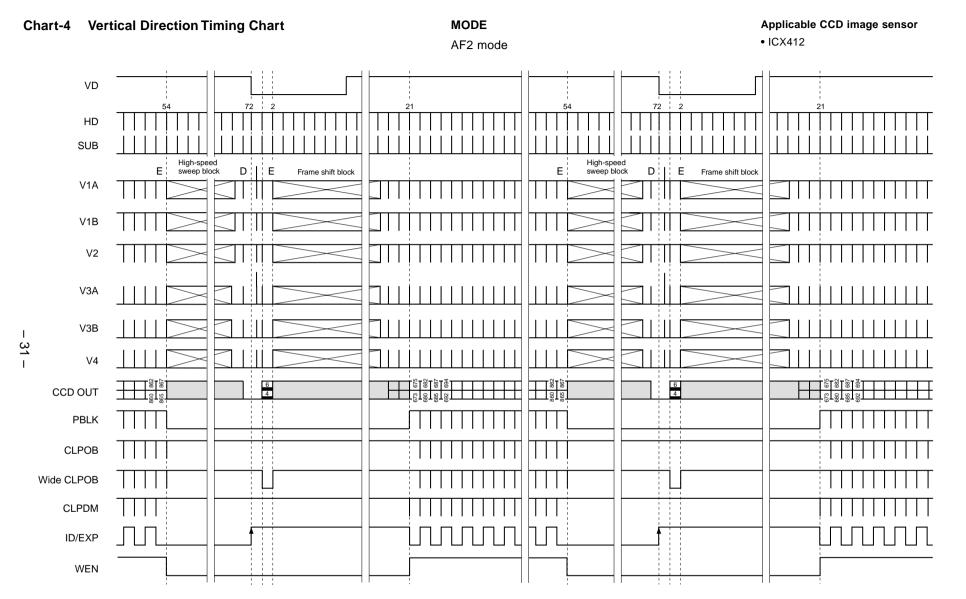
* The number of SUB pulses is determined by the serial interface data. This chart shows the case where SUB pulses are output in each horizontal period.

* ID/EXP of this chart shows ID. ID is low for lines where CCD OUT contains the R component, and high for lines where CCD OUT contains the B component.

*75 stages are fixed for high-speed sweep block; 68 stages are fixed for frame shift block.

* VD of this chart is NTSC equivalent pattern (142H + 1384ck + 1383ck units). For PAL equivalent pattern, it is 171H + 1296ck units. High-speed sweep block starts from 159H.





* The number of SUB pulses is determined by the serial interface data. This chart shows the case where SUB pulses are output in each horizontal period.

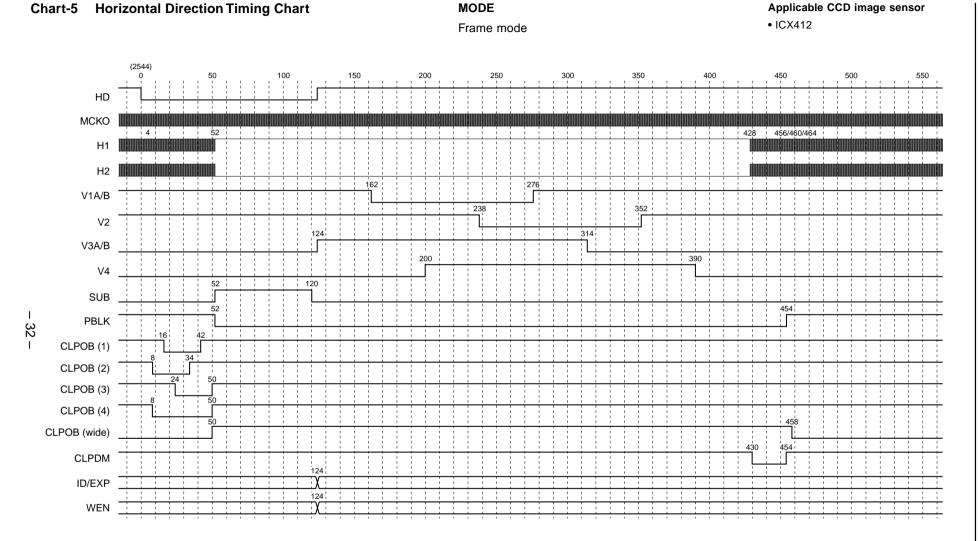
* ID/EXP of this chart shows ID. ID is low for lines where CCD OUT contains the R component, and high for lines where CCD OUT contains the B component.

* 116 stages are fixed for high-speed sweep block; 110 stages are fixed for frame shift block.

* VD of this chart is NTSC equivalent pattern (71H + 1384ck units). For PAL equivalent pattern, it is 85H + 1960ck units.

High-speed sweep block starts from 68H. However, in this case, NTSC equivalent pattern frame rate is 0.5ck longer than 1/120s.

CXD3412GA



* The HD of this chart indicates the actual CXD3412GA load timing.

* The numbers at the output pulse transition points indicate the count at the MCKO rise from the fall of HD.

* The HD fall period should be between approximately 2.3 to 19.0µs (when the drive frequency is 22.5MHz).

This chart shows a period of 124ck (5.5µs). Internal SSG is at this timing.

* SUB is output at the timing shown above when output is controlled by the serial interface data.

* ID/EXP of this chart shows ID. ID/EXP and WEN are output at the timing shown above at the position shown in Chart-1.

* CLPOB (wide) is output at the timing shown above at the position shown in Chart-1.

CXD3412GA

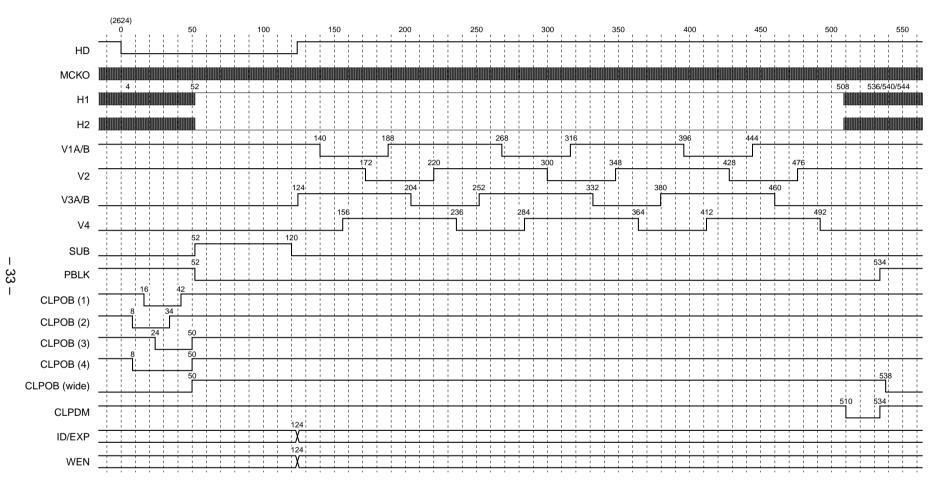
SONA

Chart-6 Horizontal Direction Timing Chart

MODE

Draft mode, AF1 mode, AF2 mode

Applicable CCD image sensor • ICX412



* The HD of this chart indicates the actual CXD3412GA load timing.

* The numbers at the output pulse transition points indicate the count at the MCKO rise from the fall of HD.

* The HD fall period should be between approximately 2.3 to 19.0µs (when the drive frequency is 22.5MHz).

This chart shows a period of 124ck (5.5µs). Internal SSG is at this timing.

* SUB is output at the timing shown above when output is controlled by the serial interface data.

* ID/EXP of this chart shows ID. ID/EXP and WEN are output at the timing shown above at the position shown in Chart-2, 3 and 4.

* CLPOB (wide) is output at the timing shown above at the position shown in Chart-2, 3 and 4.

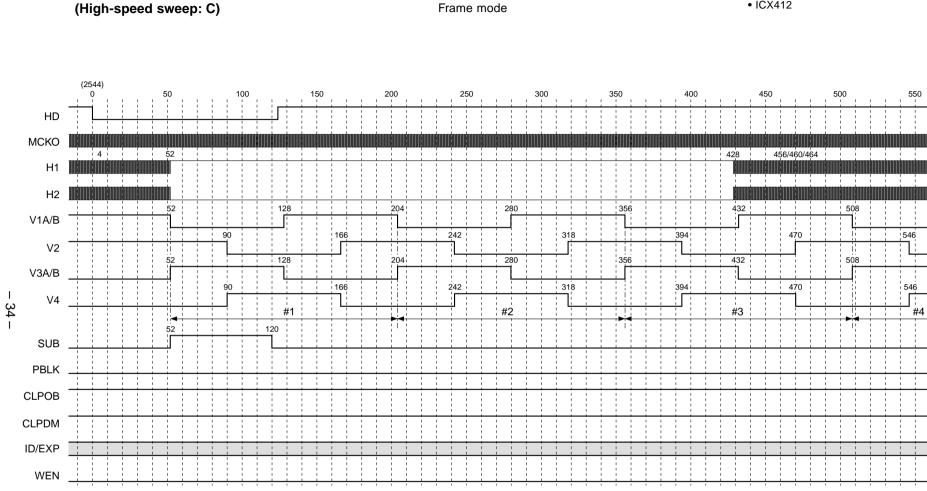


Chart-7 Horizontal Direction Timing Chart

MODE

Applicable CCD image sensor • ICX412

* The HD of this chart indicates the actual CXD3412GA load timing.

* The numbers at the output pulse transition points indicate the count at the MCKO rise from the fall of HD.

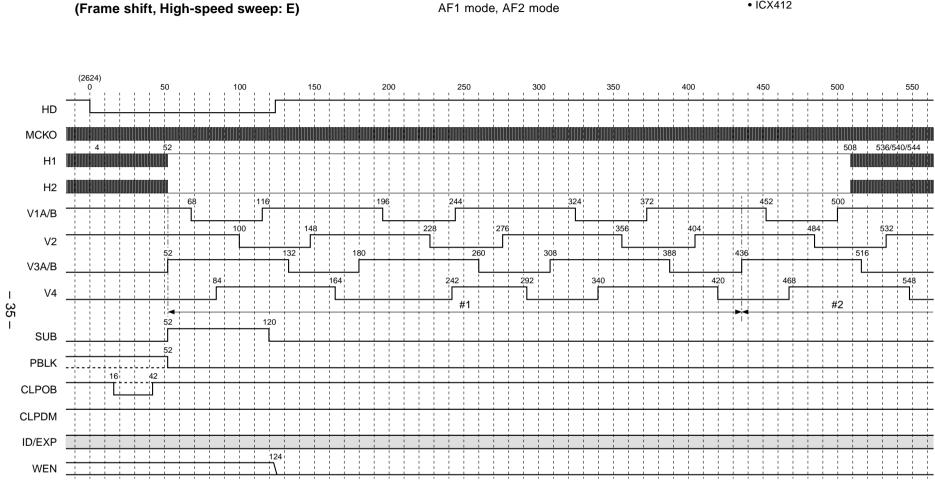
* The HD fall period should be between approximately 2.3 to 19.0µs (when the drive frequency is 22.5MHz).

This chart shows a period of 124ck (5.5µs). Internal SSG is at this timing.

* SUB is output at the timing shown above when output is controlled by the serial interface data.

* ID/EXP of this chart shows ID.

* High-speed sweep of V1A/B, V2, V3A/B and V4 is performed up to 93H 580ck (#1560).



MODE

* The HD of this chart indicates the actual CXD3412GA load timing.

Chart-8 Horizontal Direction Timing Chart

I

* The numbers at the output pulse transition points indicate the count at the MCKO rise from the fall of HD.

* The HD fall period should be between approximately 2.3 to 19.0µs (when the drive frequency is 22.5MHz).

This chart shows a period of 124ck (5.5µs). Internal SSG is at this timing.

* SUB is output at the timing shown above when output is controlled by the serial interface data.

* ID/EXP of this chart shows ID. PBLK, CLPOB, ID/EXP and WEN are output at the timing shown above at the position shown in Chart-3 and 4.

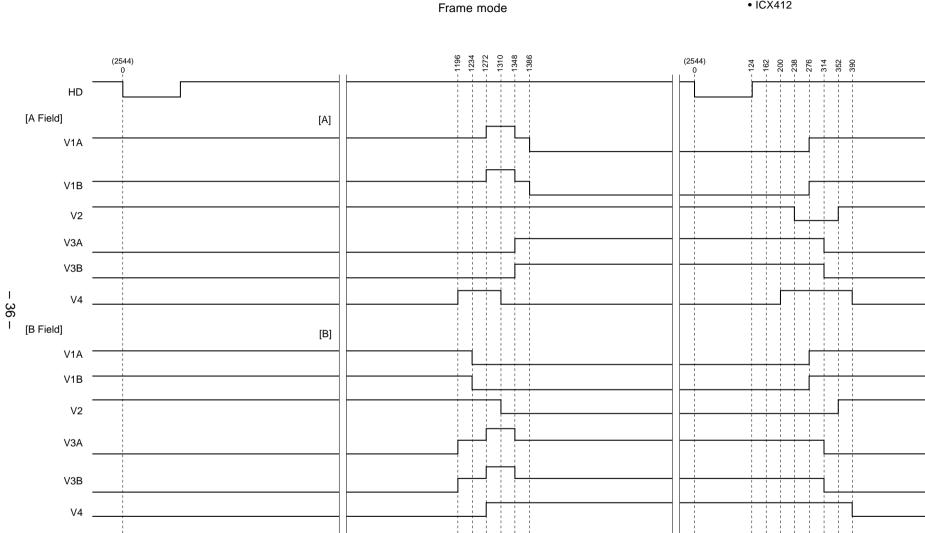
* Frame shift of V1A/B, V2, V3A/B and V4 is performed up to 11H 2548ck (#68) in AF1 mode and 18H 308ck (#110) in AF2 mode.

In addition, high-speed sweep is performed up to 141H 2612ck (#75) in AF1 mode and 70H 2612ck (#116) in AF2 mode.

NON

Applicable CCD image sensor

• ICX412



MODE

* The HD of this chart indicates the actual CXD3412GA load timing.

Chart-9 Horizontal Direction Timing Chart

* The numbers at the output pulse transition points indicate the count at the MCKO rise from the fall of HD.

* The HD fall period should be between approximately 2.3 to 19.0µs (when the drive frequency is 22.5MHz). This chart shows a period of 124ck (5.5µs). Internal SSG is at this timing.

Applicable CCD image sensor

• ICX412

CXD3412GA

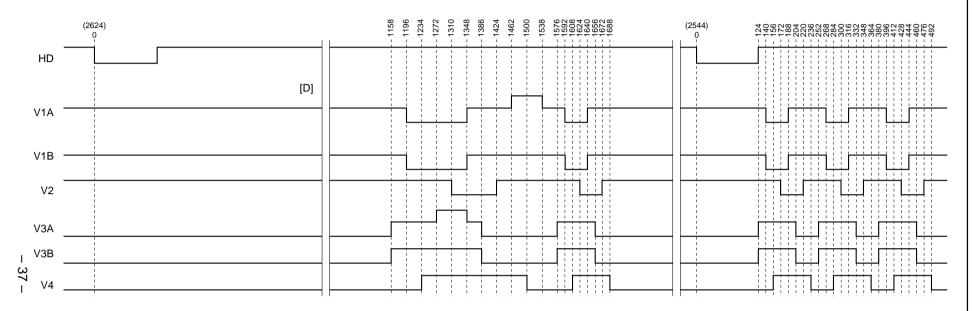
Chart-10 Horizontal Direction Timing Chart

MODE

Applicable CCD image sensor

Draft mode, AF1 mode, AF2 mode

• ICX412



* The HD of this chart indicates the actual CXD3412GA load timing.

* The numbers at the output pulse transition points indicate the count at the MCKO rise from the fall of HD.

* The HD fall period should be between approximately 2.3 to 19.0µs (when the drive frequency is 22.5MHz).

This chart shows a period of 124ck (5.5µs). Internal SSG is at this timing.

MODE

HD HD' CKI СКО ADCLK 52 428/508 MCKO H1 - 38 -H2 RG XSHP XSHD XRS

 $^{\ast}\,\text{HD}'$ indicates the HD which is the actual CXD3412GA load timing.

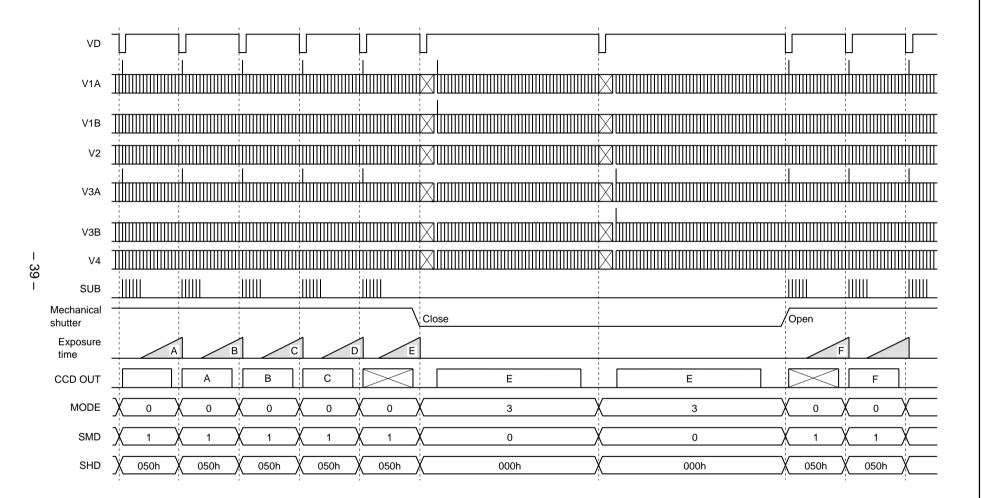
* The phase relationship of each pulse shows the logical position relationship. For the actual output waveform, a delay is added to each pulse. * The logical phase of ADCLK can be specified by the serial interface data.

NOS

MODE

Applicable CCD image sensor • ICX412

 $Draft \rightarrow Frame \rightarrow Draft$



* This chart is a drive timing chart example of electronic shutter normal operation.

* Data exposed at D includes a blooming component. For details, see the CCD image sensor data sheet.

* The CXD3412GA does not generate the pulse to control mechanical shutter operation.

* The switching timing of drive mode and electronic shutter data is not the same.

CCD Signal Processor Block Serial Interface Control

The CXD3412GA's CCD signal processor block basically loads the CCD signal processor block serial interface data sent in the following format at the rising edge of SEN2, and the setting values are then reflected to the operation 6 ADCLKI clocks after that.

CCD signal processor block serial interface control requires clock input to ADCLKI in order to load and reflect the serial interface data to operation, so this should normally be performed when the timing generator block is in the normal operation mode.

SSI2	00	01	02	03	04	05	06	07	08	09	10	11	12	13	14	15	
SCK2																	
SEN2]																

There are four categories of CCD signal processor block serial interface data: standby control data, PGA gain setting data, OB clamp level setting data, and input pulse polarity setting data.

Note that when data from multiple categories is loaded consecutively, the data for the category loaded last is valid and data from other categories is lost. When transferring data from multiple categories, raise SEN2 for each category and wait until the setting value 6 ADCKLI clocks after that has been reflected to operation, then transmit the next category.

The detail of each data are described below.

Standby	Control	Data
---------	---------	------

Data	Symbol	Function	Data = 0	Data = 1	
D00	TEST	Test code	Set to 0.		
D01 to D03	CTG	Category switching	D01 to [003 CTG	
D04 to D14	FIXED	_	Set to	All 0.	
D15	STB	Standby control	Normal operation mode	Standby mode	

PGA Gain Setting Data

Data	Symbol	Function	Function Data = 0		
D00	TEST	Test code	Set to 0.		
D01 to D03	CTG	Category switching	D01 to [003 CTG	
D04, D05	FIXED	_	Set to All 0.		
D06 to GAIN PGA gain s D15		PGA gain setting data	See D06 to	D15 GAIN.	

OB Clamp Level Setting Data

Data	Symbol	Function	Data = 0	Data = 1		
D00	TEST	Test code	Set to 0.			
D01 to D03	CTG	Category switching	D01 to [003 CTG		
D04 to D11	FIXED	—	Set to All 0.			
D12 to OBLVL OF D15		OB clamp level setting data	See D12 to	D15 OBLVL.		

Input Pulse Polarity Setting Data

Data	Symbol	Function	Data = 0	Data = 1	
D00	TEST	Test code	Set	to 0.	
D01 to D03	CTG	Category switching	D01 to [003 CTG	
D04 to D12	o FIXED —		Set to All 0.		
D13 to POL Input D15		Input pulse polarity setting data	Set to All 0.		

Detailed Description of Each Data

Shared data: D01 to D03 CTG [Category]

Of the data provided to the CXD3412GA by the CCD signal processor block serial interface, the CXD3412GA loads D04 and subsequent data to each data register as shown in the table below according to the combination of D01 to D03.

D01	D02	D03	Description of operation
0	0	0	Loading to standby control data register
0	0	1	Loading to PGA gain setting data register
0	1	0	Loading to OB clamp level setting data register
0	1	1	Loading to input pulse polarity setting data register
1	Х	Х	Access prohibited

Standby control data: D15 STB [Standby]

The operating mode of the CCD signal processor block is switched as follows. When the CCD signal processor block is in standby mode, only the serial interface is valid.

D00	Description of operation
0	Normal operating mode
1	Standby mode

PGA gain setting data: D06 to D15 GAIN [PGA gain]

The CXD3412GA can set the programmable gain amplifier (PGA) gain from –6dB to +42dB in 1024 steps by using PGA gain setting data D06 to D15 GAIN.

The PGA gain setting data is expressed as shown in the table below using D06 to D15 GAIN.

MSB									LSB
D06	D07	D08	D09	D10	D11	D12	D13	D14	D15
0	1	1	1	0	0	0	0	1	1
\downarrow		\downarrow				\downarrow			
1		С				3			

GAIN is expressed as 1C3h.

For example, when GAIN is set to "000h", "080h", "220h", "348h" and "3FFh", the respective PGA gain setting values are –6dB, 0dB, +20dB, +34dB and +42dB.

OB clamp level setting data: D12 to D15 OBLVL [OB clamp output]

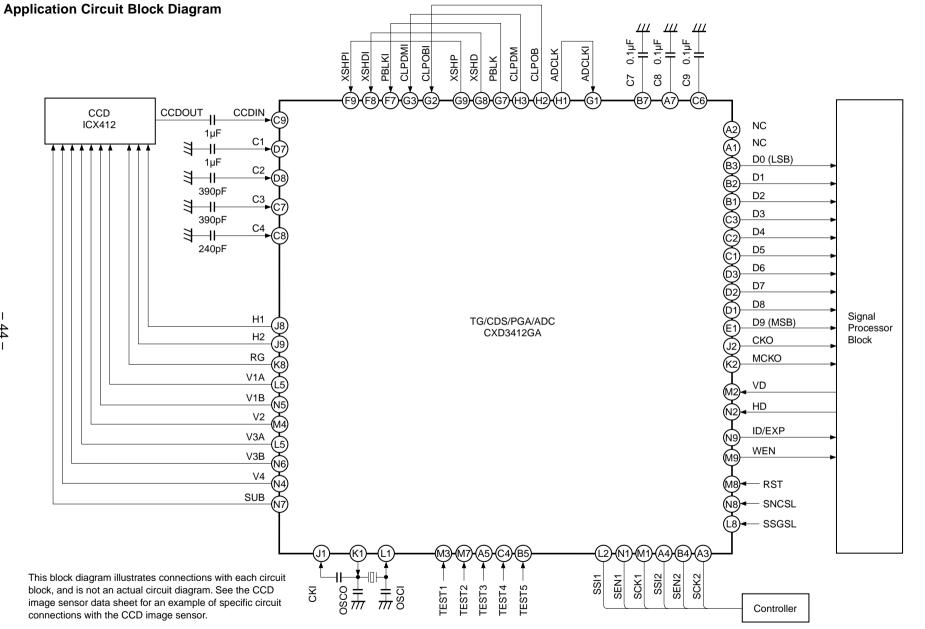
The CXD3412GA can set the OPB clamp output value from 0 to 60LSB in 4LSB steps by using CCD signal processor block control data D12 to D15 OBLVL.

The OPB clamp output setting data is expressed as shown in the table below using D12 to D15 OBLVL.

MSB			LSB						
D12	D13	D14	D15						
0	1	1	0						
\downarrow									
6									

OBLVL is expressed as 6h.

For example, when OBLVL is set to "0h", "1h", "8h" and "Fh", the respective OPB clamp output setting values are 0LSB, 4LSB, 32LSB and 60LSB.



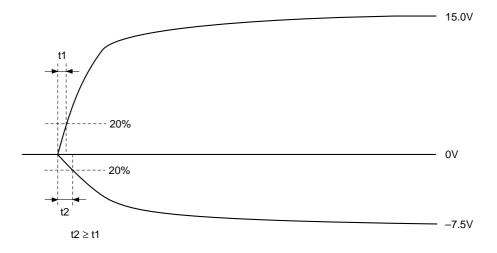
Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

44 T

NON

Notes on Operation

 Be sure to start up the timing generator block VL and VH pin power supplies at the timing shown in the figure below in order to prevent the SUB pin of the CCD image sensor from going to negative potential. In addition, start up the timing generator block VbD1, VbD2, VbD3, VbD4 and VbD5 pin and CCD signal processor block DVbD1, DVbD2, AVbD1, AVbD2, AVbD3, AVbD4 and AVbD5 pin power supplies at the same time either before or at the same time as the VH pin power supply is started up.



- Reset the timing generator block and CCD signal processor block during power-on. The timing generator block is reset by inputting the reset signal to the RST pin. The CCD signal processor block is reset by initializing the serial data.
- Separate the timing generator block VDD1, VDD2, VDD3, VDD4 and VDD5 pins from the CCD signal processor block DVDD1, DVDD2, AVDD1, AVDD2, AVDD3, AVDD4, and AVDD5 pins.
 Also, the ADC output driver stage is connected to the dedicated power supply pin DVDD1. Separating this pin from other power supplies is recommended to avoid affecting the internal analog circuits.
- 4. The difference in potential between the timing generator block VDD4 pin supply voltage 3 VDDc and the CCD signal processor block DVDD1, DVDD2, AVDD1, AVDD2, AVDD3, AVDD4 and AVDD5 pin supply voltages 1 VDDe, 2 VDDf and 3 VDDg should be 0.1V or less.
- 5. The timing generator block and CCD signal processor block ground pins should use a shared ground which is connected outside the IC. When the set ground is divided into digital and analog blocks, connect the timing generator block ground pins to the digital ground and the CCD signal processor block ground pins to the analog ground. The difference in potential between the timing generator block Vss1, Vss2, Vss3, Vss4, Vss5, Vss6 and VM and the CCD signal processor block DVss1, DVss2, DVss3, AVss1, AVss2, AVss3, AVss4, AVss5 and AVss6 should be 0.1V or less.
- 6. Do not perform serial communication with the CCD signal processor block during the effective image period, as this may cause the picture quality to deteriorate. In addition, using SCK2, SSI2 and SEN2, which are used by the CCD signal processor block, use of the dedicated ports is recommended. When using these pins as shared ports with the timing generator block or other ICs, be sure to thoroughly confirm the effects on picture quality before use.

Package Outline Unit: mm

